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Richtek USA Inc. RT9147ZQW

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# 20V, 1A, Rail-to-Rail Operational Amplifier

# **General Description**

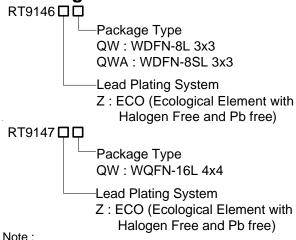
The RT9146/7 consists of a low power, high slew rate, single supply rail-to-rail input and output operational amplifier.

The RT9146 contains a single amplifier and the RT9147 contains two amplifiers in one package.

The RT9146/7 has a high slew rate (35V/ $\mu$ s), 1A peak output current and offset voltage below 15mV. The RT9146/7 is ideal for Thin Film Transistor Liquid Crystal Displays (TFT-LCD).

The RT9146 is available in the WDFN-8L 3x3 package, and the RT9147 is available in the WQFN-16L 4x4 package. The RT9146/7 are specified for operation over the full  $-40^{\circ}$ C to 85°C temperature range.

### **Ordering Information**



Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

#### **Features**

Rail-to-Rail Output Swing

Supply Voltage : 6V to 20V

Peak Output Current : 1A
High Slew Rate : 35V/μs

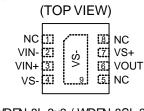
• Unity Gain Stable

• RoHS Compliant and Halogen Free

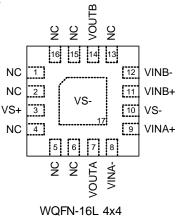
### **Applications**

- TFT-LCD Panels
- Notebook Computers
- Monitors
- LCD TVs

#### **Pin Configurations**



WDFN-8L 3x3 / WDFN-8SL 3x3 RT9146



WQFN-16L 4x4 RT9147

# Marking Information RT9146ZQW

85 YM DNN 85 : Product Code YMDNN : Date Code 2W YM DNN

2W : Product Code YMDNN : Date Code RT9147ZQW

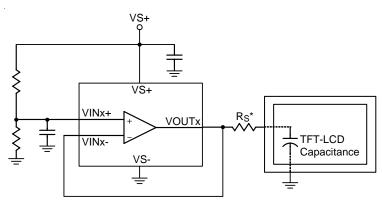
43 YM DNN 43 : Product Code YMDNN : Date Code

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# **Typical Application Circuit**



<sup>\*:</sup> R<sub>S</sub> may be needed for some applications.

### **Functional Pin Description**

#### RT9146

Pin No.					
WDFN-8L 3x3	WDFN-8SL 3x3	Pin Name	Pin Function		
1, 5, 8		NC	No Internal Connection.		
2		VIN-	Negative Input.		
3		VIN+	Positive Input.		
4, 9 (Exposed Pad)		VS-	Negative Supply Input. The exposed pad must be soldered to a large F and connected to VS- for maximum power dissipation.		
6		VOUT	Output.		
7		VS+	Positive Supply Input. Bypass VS+ to VS– with a $0.1\mu F$ capacitor placed close as possible to the device.		

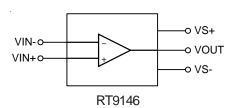
#### RT9147

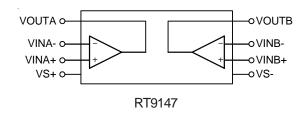
Pin No.	Pin Name	Pin Function		
1, 2, 4, 5, 6, 13, 15, 16	NC	No Internal Connection.		
3	VS+	Positive Supply Input. Bypass VS+ to VS– with a 0.1 $\mu F$ capacitor placed allose as possible to the device.		
7	VOUTA	Output of Amplifier A.		
8	VINA-	Positive Input of Amplifier A.		
9	VINA+	Negative Input of Amplifier A.		
10, 17 (Exposed Pad)	VS-	Negative Supply Input. The exposed pad must be soldered to a large PCB and connected to VS- for maximum power dissipation.		
11	VINB+	Positive Input of Amplifier B.		
12	VINB-	Negative Input of Amplifier B.		
14	VOUTB	Output of Amplifier B.		



# RT9146/7

### **Function Block Diagram**







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<b>Absolute Maximum</b>	Ratings	(Note 1)
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• Supply Voltage, (VS+ to VS-)	24V
• VINx+, VINx- to VS	
• VINx+ to VINx	
• Power Dissipation, P <sub>D</sub> @ T <sub>A</sub> = 25°C	
WDFN-8L 3x3	3.22W
WDFN-8SL 3x3	3.22W
WQFN-16L 4x4	
Package Thermal Resistance (Note 2)	
WDFN-8L 3x3, θ <sub>JA</sub>	31°C/W
WDFN-8L 3x3, θ <sub>JC</sub>	8°C/W
WDFN-8SL 3x3, $\theta_{JA}$	31°C/W
WDFN-8SL 3x3, $\theta_{JC}$	8°C/W
WQFN-16L 4x4, $\theta_{JA}$	28.5°C/W
WQFN-16L 4x4, $\theta_{JC}$	7°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	150°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
MM (Machine Model)	200V
Recommended Operating Conditions (Note 4)	
• Supply Voltage, VS- = 0V, VS+	6V to 20V

- cappi, romage, re-	0. 10 = 0.
• Junction Temperature Range	40°C to 125°C
Ambient Temperature Penge	400C to 0E0C

#### 

#### **Electrical Characteristics**

 $(V_{S+} = 16V, V_{S-} = 0V, V_{INx+} = V_{OUTx} = V_{S+} / 2, T_A = 25^{\circ}C, unless otherwise specified)$ 

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Characteristics						
Input Offset Voltage	Vos	V <sub>CM</sub> = V <sub>S+</sub> / 2		2	15	mV
Input Bias Current	I <sub>B</sub>	V <sub>CM</sub> = V <sub>S+</sub> / 2		2	50	nA
Land Daniel Car	$\Delta V_{LOAD}$	I <sub>OUTx</sub> = 0 to -80mA		0.1		mV/mA
Load Regulation		I <sub>OUTx</sub> = 0 to 80mA		-0.1		
Common Mode Input Range	CMIR		0.5		V <sub>S+</sub> -0.5	V
Common Mode Rejection Ratio	CMRR	$0.5V \leq V_{OUTx} \leq V_{S+} - 0.5V$		95		dB
Open Loop Gain	A <sub>VOL</sub>	$0.5V \leq V_{OUTx} \leq V_{S+} - 0.5V$		118		dB



# RT9146/7

Parameter	Parameter Symbol Test Conditions		Min	Тур	Max	Unit
Output Characteristics						
Output Swing Low	V <sub>OL</sub>	$I_L = -50 \text{mA}$		0.6	1.5	V
Output Swing High	V <sub>OH</sub>	I <sub>L</sub> = 50mA	V <sub>S+</sub> - 1.5	V <sub>S+</sub> - 0.3		V
Transient Peak Output Current	I <sub>PK</sub>		800	1000	1400	mA
Power Supply						
Power Supply Rejection Ratio	PSRR	$V_{S+} = 6V \text{ to } 20V, V_{CM} = V_{OUTx} = V_{S+} / 2$		96		dB
Quiescent Current	$I_{DD}$	No Load		4		mA
Dynamic Performance						
Slew Rate	SR	4V step, 20% to 80%, A <sub>V</sub> = 1		35		V/μs
Setting to ±0.1% (AV = 1)	t <sub>S</sub>	$A_V = 1$ , $V_{OUTx} = 2V$ step $R_L = 10k\Omega$ , $C_L = 10pF$		270		ns
-3dB Bandwidth	BW	$R_L = 10k\Omega$ , $C_L = 10pF$		16		MHz
Gain-Bandwidth Product	GBWP	$R_L = 10k\Omega$ , $C_L = 10pF$		12		MHz
Phase Margin	PM	$R_L = 10k\Omega$ , $C_L = 10pF$		50°		
Thermal Shutdown Temperature	T <sub>S</sub>	Temperature Rising		150		°C
Thermal Shutdown Hysteresis	ΔTs			20		°C

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2.  $\theta_{JA}$  is measured at  $T_A = 25^{\circ}C$  on a high effective thermal conductivity four-layer test board per JEDEC 51-7.  $\theta_{JC}$  is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

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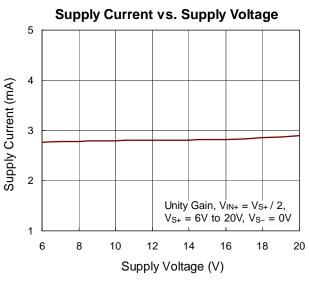
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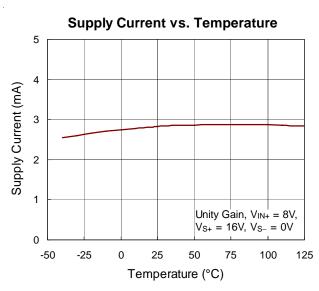
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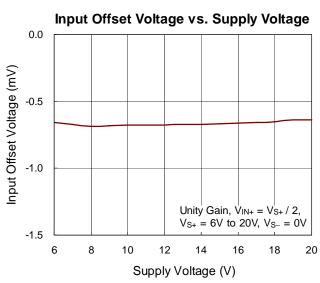


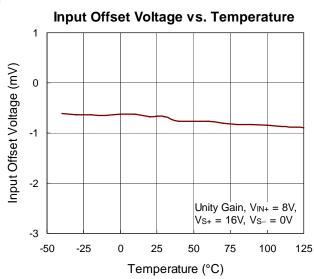
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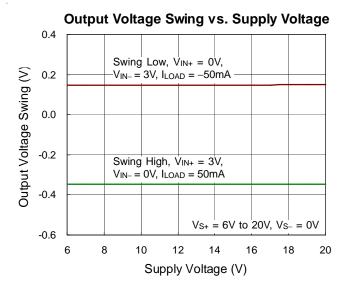
### **Typical Operating Characteristics**



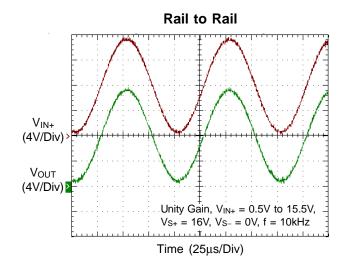






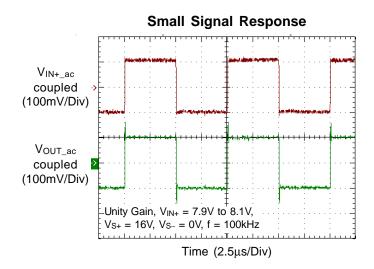


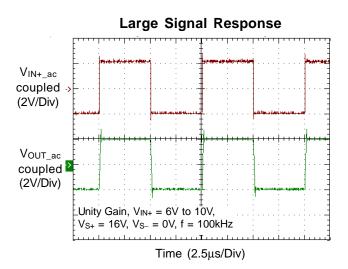
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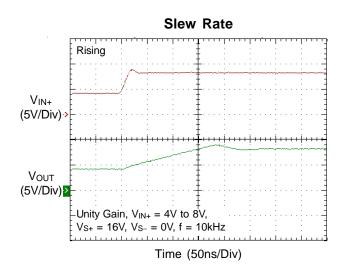


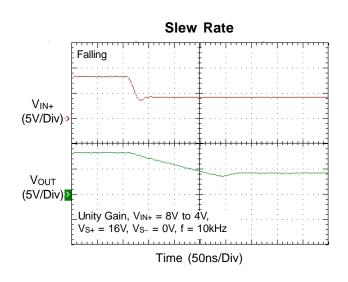


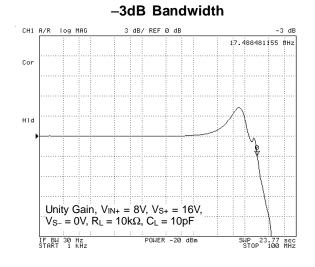
# RT9146/7

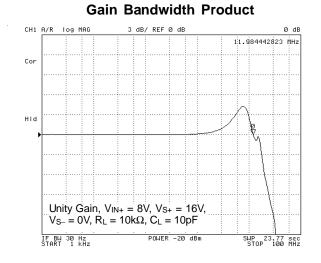












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### **Applications Information**

The RT9146/7 is a high performance operational amplifier capable of driving large loads for different applications. A high slew rates, rail-to-rail input and output capability, and low power consumption are the features which make the RT9146/7 ideal for LCD applications. The RT9146/7 also has wide bandwidth and phase margin to drive a load with  $10k\Omega$  resistance and 10pF capacitance.

#### **Operating Voltage**

The RT9146/7 total supply voltage range is guaranteed from 6V to 20V. The specifications are stable over both full supply range and operating temperatures from –40°C to 85°C. The output swing of the RT9146/7 typically extends to within 1.5V of positive/negative supply rails with 50mA load current source/sink. Decreasing the load current will obtain an output swing even closer to the supply rails.

#### **Short-Circuit Condition**

An internal short-circuit protection is implemented to protect the device from output short-circuit. The RT9146/7 limits the short-circuit current to  $\pm 1A$  if the output is directly shorted to positive/negative supply rails.

#### **LCD Panel Applications**

The RT9146/7 is mainly designed for LCD V-com buffer. The operational amplifier has 1A instantaneous source/ sink peak current.

#### **Thermal Considerations**

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance,  $\theta_{JA}$ , is layout dependent. For WDFN-8L 3x3 package, the thermal resistance,  $\theta_{JA}$ , is 31°C/W on a standard JEDEC 51-7 four-layer thermal test board. For WDFN-8SL 3x3 package, the thermal resistance,  $\theta_{JA}$ , is 31°C/W on a standard JEDEC 51-7 four-layer thermal test board. For WQFN-16L 4x4 package, the thermal resistance,  $\theta_{JA}$ , is 28.5°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at  $T_A$  = 25°C can be calculated by the following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (31^{\circ}C/W) = 3.22W$  for WDFN-8L 3x3 package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (31^{\circ}C/W) = 3.22W$  for WDFN-8SL 3x3 package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (28.5^{\circ}C/W) = 3.51W$  for WQFN-16L 4X4 package

The maximum power dissipation depends on the operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance,  $\theta_{JA}$ . The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

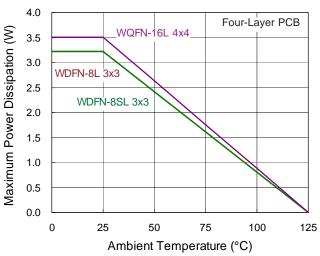


Figure 1. Derating Curve of Maximum Power Dissipation



#### **Layout Consideration**

PCB layout is very important for designing power converter circuits. The following layout guidelines should be strictly followed for best performance of the RT9146/7.

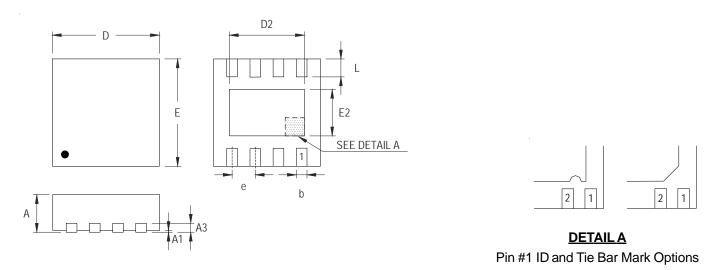
- Place the power components as close to the IC as possible. The traces should be wide and short, especially for the high current loop.
- ▶ A series resistance may be needed at the output for some applications.
- Connect a 0.1μF capacitor from VINx+ to ground and place it as close to the IC as possible for better performance.
- ➤ The exposed pad of the chip should be connected to a large PCB plane for maximum thermal consideration.

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### **Outline Dimension**



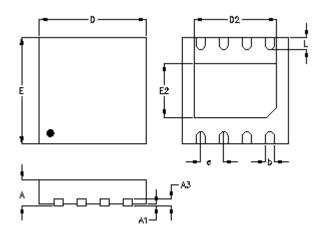
Note: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

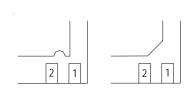
Compleal	Dimensions I	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.175	0.250	0.007	0.010	
b	0.200	0.300	0.008	0.012	
D	2.950	3.050	0.116	0.120	
D2	2.100	2.350	0.083	0.093	
Е	2.950	3.050	0.116	0.120	
E2	1.350	1.600	0.053	0.063	
е	0.650		0.0	26	
L	0.425	0.525	0.017	0.021	

W-Type 8L DFN 3x3 Package



# RT9146/7





**DETAIL A**Pin #1 ID and Tie Bar Mark Options

Note: The configuration of the Pin #1 identifier is optional,

but must be located within the zone indicated.

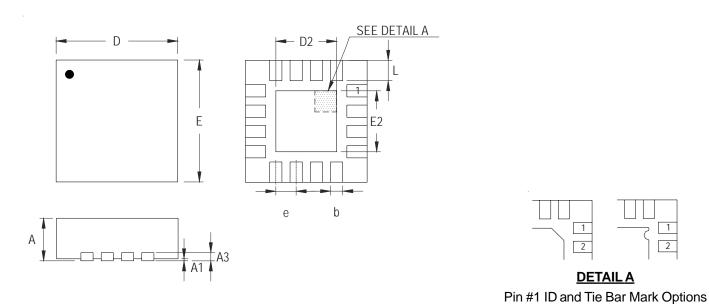
Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
А3	0.175	0.250	0.007	0.010	
b	0.200	0.300	0.008	0.012	
D	2.900	3.100	0.114	0.122	
D2	2.250	2.350	0.089	0.093	
E	2.900	3.100	0.114	0.122	
E2	1.450	1.550	0.057	0.061	
е	0.650		0.0	26	
L	0.300	0.400	0.012	0.016	

W-Type 8SL DFN 3x3 Package

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Note: The configuration of the Pin#1 identifier is optional, but must be located within the zone indicated.

O b. a.l	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A3	0.175	0.250	0.007	0.010	
b	0.250	0.380	0.010	0.015	
D	3.950	4.050	0.156	0.159	
D2	2.000	2.450	0.079	0.096	
Е	3.950	4.050	0.156	0.159	
E2	2.000	2.450	0.079	0.096	
е	0.650		0.0	26	
L	0.500	0.600	0.020	0.024	

W-Type 16L QFN 4x4 Package

#### **Richtek Technology Corporation**

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